BOARD TITLE: PAINEL_MEB

AUTHOR: CCB
CODE NUMBER:
REVISION: 1_00
LAYER STACKUP:

TOP & BOTTOM: SIGNAL + GND PLANE

GENERAL NOTES:

1. LAMINATE SPECIFICATIONS:

- TOTAL THICKNESS: 1.6 mm +/- 0.2 mm
- LAYER NUMBERS: 2
- Cu THICKNESS (FINISHED):

1 oz / 1 oz

- RAW MATERIAL: FR-4

- TG MIN.: 150 °C - TD MIN.: 310 °C

2. HOLE CHARACTERISTICS:

- PLATED HOLE TOLERANCE: +/- 0.1 mm
- NON PLATED HOLE TOLERANCE: +/- 0.1 mm
- DISPLACEMENT: 0.1 mm MAX.
- Cu THICKNESS ON HOLE: 20 um + SnPb MIN.

3. FINISHING:

- HOT AIR SOLDER LEVELING (HASL) - SnPb

4. SILKSCREEN MASK:

REVISIONS DESCRIPTION:

- WHITE (THERMAL CURE EPOXY)

5. SOLDER MASK:

- BOTH SIDES
- GREEN EPOXY THERMAL CURE OR PHOTO IMAGEABLE
- IONIC CONTAMINATION AFTER SOLDERING: 14 ug NaCI / in2 MAX.
- COVER VIAS WITH SOLDER MASK ON BOTH SIDES

6. SPECIFIED STANDARDS:

- IPC-6011 CLASS 2 / IPC-6012 CLASS 2 / IPC-A-600 CLASS 2

7. ADDITIONAL NOTES:

- DIMENSIONAL TOLERANCE: +/- 0.2 mm
- ELECTRICAL TESTS ARE MANDATORY
- GERBER MODIFICATIONS ARE ONLY ALLOWED WITH EXPLICIT AUTHOR / RESPONSIBLE AUTHORIZATION

